

Date: 12/05/2026

DEKRA Testing and Certification, S.A.U.
Parque Tecnológico de Andalucía
C/ Severo Ochoa 2 & 6
29590 Campanillas
Málaga, España

Ref: Family Cover letter for FCC ID T8GIDCEVORSE

Dear Sir or Madam,

This letter serves as an attestation that **HARMAN International**, as the system integrator and manufacturer of the end product for the **IDCEVO-RSE_EXBX** project, confirms compliance with the applicable **Transmit Power Control** requirements.

The wireless functionality of the HARMAN product integrates an **Infineon Technologies** wireless chipset. The implementation of the TPC mechanism is based on the chipset functionality provided by Infineon and is not modified or overridden by HARMAN at system level.

Spectrum Prioritization Above 6.105 GHz

We hereby attest that this device is designed and configured to prioritize spectrum usage above 6.105 GHz. The device's radio firmware ensures that, during normal operation, channel selection mechanisms give precedence to channels whose center frequencies lie above 6.105 GHz.

TPC Compliance Statement

HARMAN hereby attests that for the IDCEVO-RSE_EXBX project:

1. The TPC mechanism is not user-configurable and is enforced automatically by the chipset and system configuration.
2. Final transmit power is enforced as a fixed offset, limited by the minimum of:
 - Hardware / board power limits
 - Regulatory limits defined in the Country Locale Map (CLM)
3. Transmit power values defined in the CLM are static (fixed) and configured per data rate, bandwidth, and channel.
4. Antenna configuration is considered in the applied CLM settings.
5. The CLM is not accessible or modifiable by the end user.
6. All transmitted frames operate within the applicable regulatory limits.

HARMAN

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The detailed TPC mechanism and its regulatory compliance are defined by **Infineon Technologies** as the chipset manufacturer. The corresponding Infineon TPC attestation is provided in a separate declaration. (FCC_attestation 6G_VLP)

This attestation applies exclusively to the IDCEVO-RSE_EXBX project and the related product configurations integrating the referenced Infineon chipset. It is issued for certification and compliance purposes.

Sincerely,


(signature & company stamp)

Stefan Blaschek
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(signature & company stamp)

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